



PARA LIGHT ELECTRONICS CO., LTD. 4F, No.1, Lane 93, Chien Yi Road, Chung Ho City, Taipei, Taiwan

4F, No.1, Lane 93, Chien Yi Ro Tel: 886-2-2225-3733 E-mail: <u>para@para.com.tw</u>

Road, Chung Ho City, Taipei, Taiv Fax: 886-2-2225-4800 http://www.para.com.tw

DATA SHEET

PART NO.: L-T2835WDT-WW1-HX

REV: <u>A/0</u>

CUSTOMER'S APPROVAL : ____ DRAWING NO. : DS-31P-18-0202

_____ DATE :2018-10-31

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PARA-FOR-065



Part No. : L-T2835WDT-WW1-HX

REV: A/0

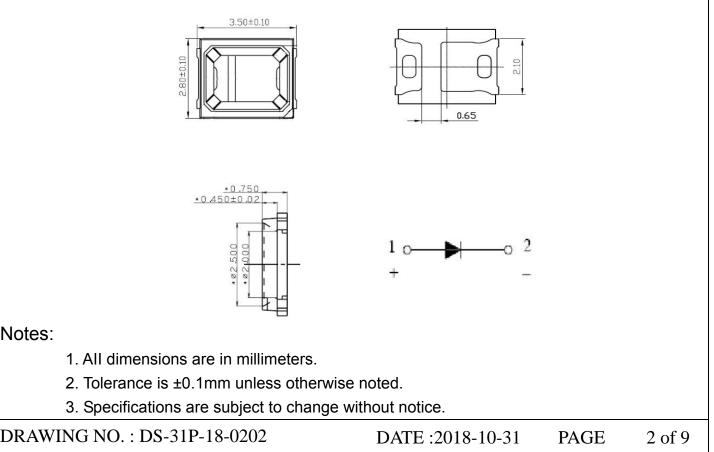
Features

- *Low power consumption
- * Available in various colors
- *Long life span (up to 3000hours)
- * Soldering methods: IR reflow soldering and Hand soldering
- * high brightness surface mount technology, for safe touch
- * 120° C Emitting viewing angle 120° C
- ROHS standard. *

Application

- *Automotive
- * Backlighting
- *Decorative light
- Appliance light *
- Sign and Channel Letter *
- indicators . Comsumer . industrial . electronics. *

Package Outline Dimensions



Notes:



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Release by PARALIGHTDCC

● Maximum Ratings(Ta=25°C)

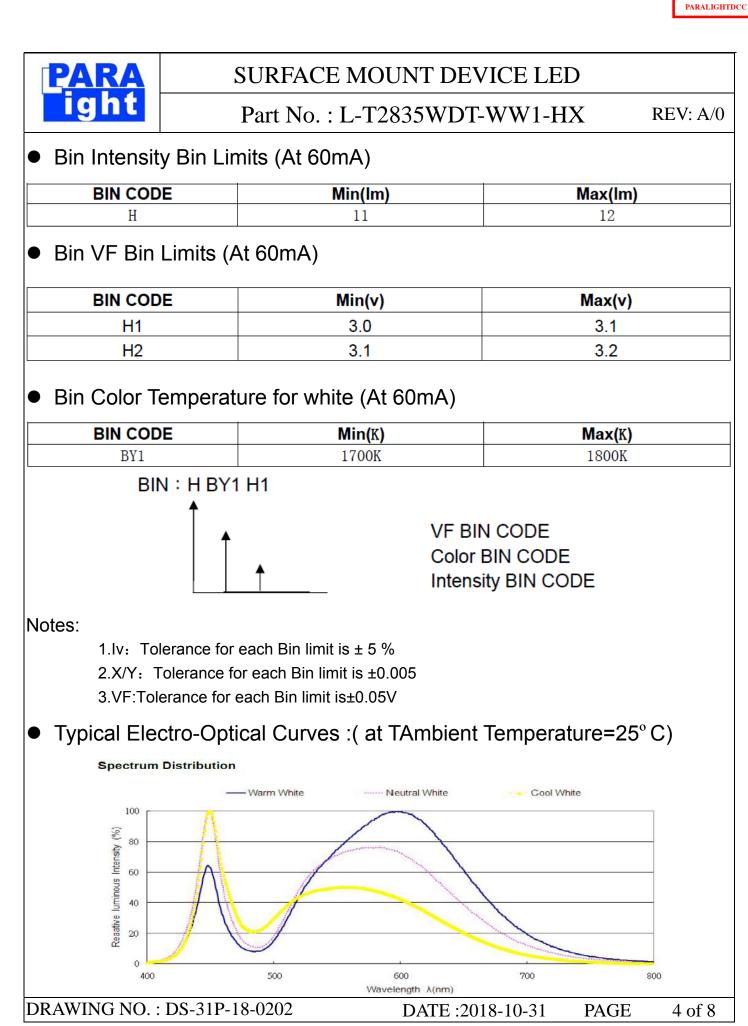
Parameter	Symbol	Rating	Unit
Power Dissipation	PD	200	mW
Forward Current *1	IF	40	mA
Operating Temperature	Topr	-40~+80	oC
Range			
Storage Temperature	Tstg	-40~+100	°C
Range			
Reverse Voltage	VR	5	V
Soldering Temperature	Tsol	260 ± 5	°C
(T=5 sec)			

*1Proper current derating must be followed to keep LED junction temperature (TJ) below the maximum.

*2 Condition for IFP is pulse of 1/10 duty and 3 msec width.

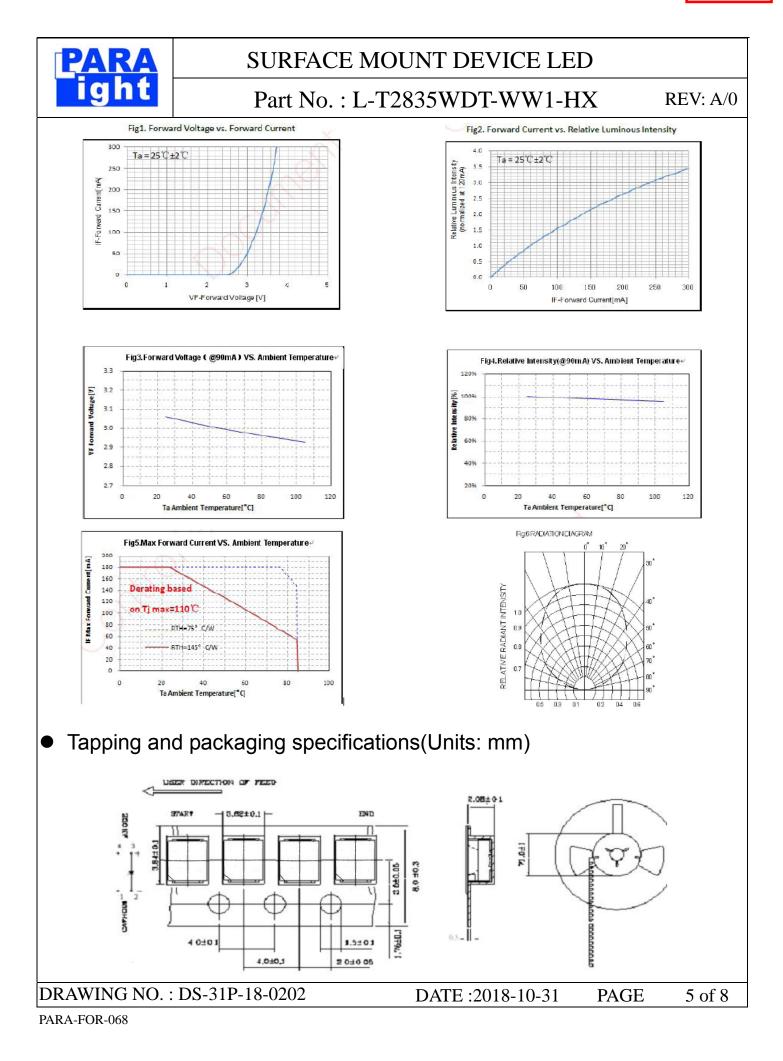
• Electrical - Optical Characteristics (Ta =25°C)

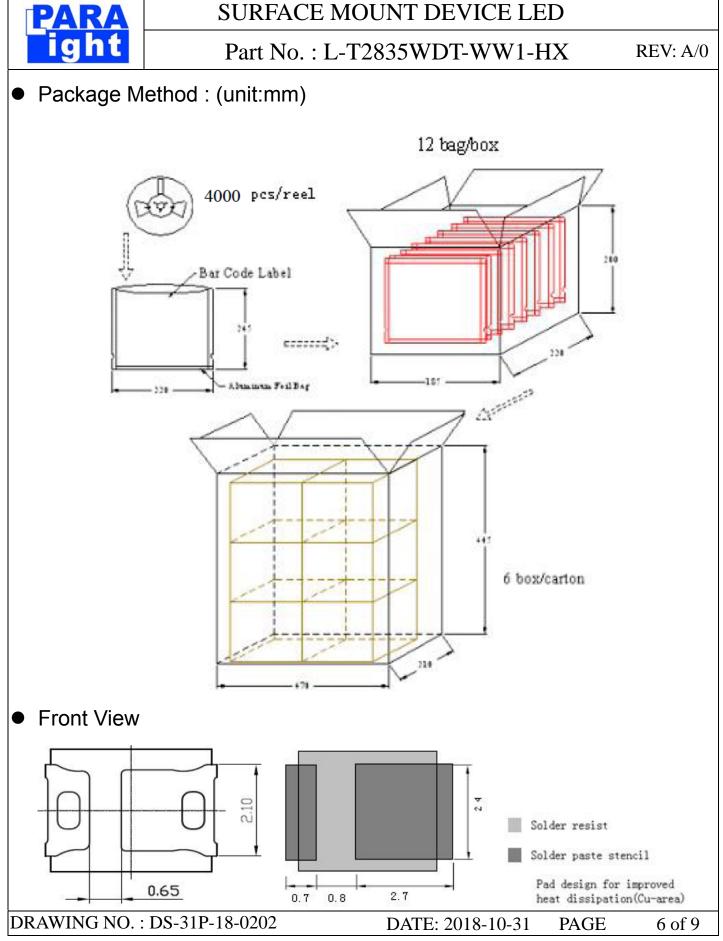
SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
VF	IF = 60mA	3.0		3.2	V
Φ	IF = 60mA	11		12	Lm
ССТ	IF = 60mA	1700		1800	К
CIE x	IF = 60mA	0.56		0.575	
CIE y	IF = 60mA	0.42		0.43	
IR	VR=5V	0		10	μA
201/2	IF = 60mA		120		degre
					е
Ra	IF = 60mA	50			%
	VF Φ CCT CIE x CIE y IR 201/2	VFIF = $60mA$ Φ IF = $60mA$ CCTIF = $60mA$ CIE xIF = $60mA$ CIE yIF = $60mA$ IRVR= $5V$ $201/2$ IF = $60mA$	VF IF = 60mA 3.0 Φ IF = 60mA 11 CCT IF = 60mA 1700 CIE x IF = 60mA 0.56 CIE y IF = 60mA 0.42 IR VR=5V 0 201/2 IF = 60mA 0	VF IF = 60mA 3.0 Φ IF = 60mA 11 CCT IF = 60mA 1700 CIE x IF = 60mA 0.56 CIE y IF = 60mA 0.42 IR VR=5V 0 201/2 IF = 60mA 120	VF IF = 60mA 3.0 3.2 Φ IF = 60mA 11 12 CCT IF = 60mA 1700 1800 CIE x IF = 60mA 0.56 0.575 CIE y IF = 60mA 0.42 0.43 IR VR=5V 0 10 201/2 IF = 60mA 120



Release by

PARA-FOR-068







Part No. : L-T2835WDT-WW1-HX

REV: A/0

• Reliability Test

Classification	Test Item	Reference Standard	Test Conditions	Result
Endurance Test	Operation Life	MIL-STD-750:1026 MIL-STD-883:1005 JIS-C-7021 :B-1	I⊧=150mA T a=Under room temperature Test time=1,000hrs	0/20
	High Temperature High Humidity Storage	MIL-STD-202:103B JIS-C-7021 :B-11	Ta=+65°C±5°C RH=90%-95% Test time=168hrs	0/20
	High Temperature Storage	MIL-STD-883:1008 JIS-C-7021 :B-10	High Ta=+85°C±5°C Test time=1,000hrs	0/20
	Low Temperature Storage	JIS-C-7021 :B-12	Low Ta=-35°C±5°C Test time=1,000hrs	0/20
	Temperature Cycling	MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1010 JIS-C-7021 :A-4	-35℃ ~ +25℃ ~ +85℃ ~ +25℃ 60min 20min 60min 20min Test Time=5cycle	0/20
Environmental Test	Thermal Shock	MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1011	-35°C±5°C ~+85°C±5°C 20min 20min Test Time=10cycle	0/20
	Solder Resistance	MIL-STD-202:201A MIL-STD-750:2031 JIS-C-7021 :A-1	Preheating : 140°C-160°C,within 2 minutes. Operation heating : 260°C (Max.), within 10seconds. (Max.)	0/20

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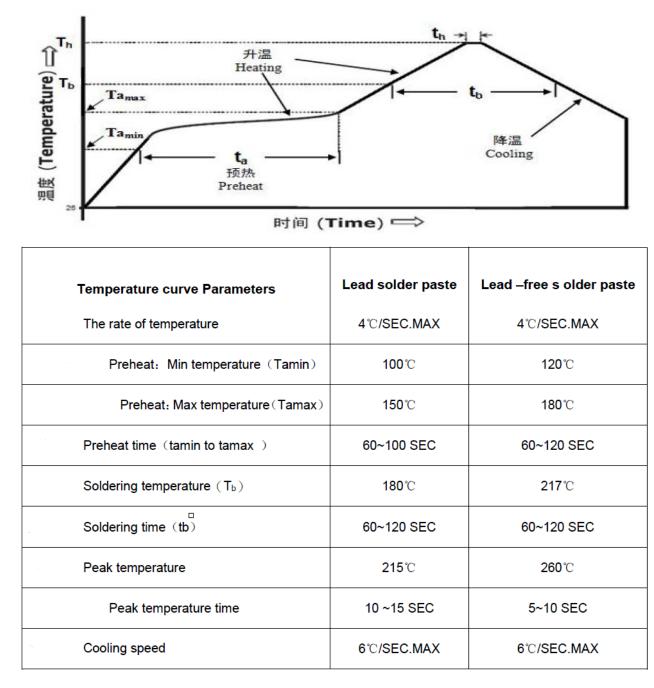
REV: A/0

Soldering

1. Manual Soldering

The temperature of the iron tip should not be higher than 350 ℃ and Soldering time to be within 3 seconds per solder-pad.

2. Reflow Soldering Temp/Time



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Judgment criteria of failure for the reliability

Measuring items	Symbol	Measuring conditions	Judgement criteria for failure
	V _F (V)	l⊧=40mA	Over U ¹ x1.2
Forward voltage			
• • •	I _R (uA)	V _R =5V	Over U ¹ x2
Reverse current			
	lv(mcd)	I _F =40mA	Below S ¹ X0.5
Luminous intensity			

Note:

1.U means the upper limit of specified characteristics. S means initial value.

2. After each test, remove test pieces, wait for 2 hours and test pieces have returned to ambient temperature, then take next measurement

• torage

- 1. recommended storage condition: At 5 $^\circ$ C-30 $^\circ$ C and relative humidity 60 $^{\%}$ RH Max.
- 2. After this bag is opened, devices that will be applied to infrared reflow,vapor-phase reflow, or equivalent oldering process must be:
- a. ompleted within 24 hours
- b. 30%RHStored at less than 30% RH.
- 3. Devices require baking before mounting, if: 2a or 2b is not met.
- 4. If baking is required, devices must be baked under below conditions: 12 hours at 60°C±3°C

• Note:

- 1. Care must be taken not to damage LED's silicone resin while exposing to high temperature or contact LED's esilicone resin with hard or sharp objects, such as metal hook, tweezer or sand blasting.
- 2. Current limiting resistor must be used in the circuit to drive Grand LEDs within the rated figures and not to overload Grand LEDs with instantaneous voltage at the turning ON and OFF cycles. When using pulse driving, the average current must be within the rated figures. And the circuit should be designed to avoid reverse voltage when turning off the Grand LEDs.
- Package and Label of Products :

Package: Products are packed in one bag of 4000 pcs (one taping reel) and a label is attached to each bag. >

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